PCB TECHNOLOGY



CONTENTS

WHAT IS PCB

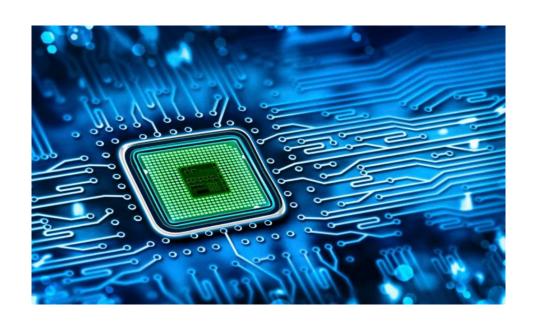
PCB CLASSFICATION

3 PCB MANUFACTURING PROCESS



WHAT IS PCB

01 WHAT IS PCB



A printed circuit board (PCB) mechanically supports and electrically connects electronic components using conductive tracks, pads and other features etched from copper sheets laminated onto a non-conductive substrate. Components are generally soldered on the PCB.-----wiki





BY MATERIAL



BY LAYER



BY VIAS



BY SURFACE FINISH



BY HARDNEDD



Organic material

Phenolic resin, glass fiber/epoxy, Polyimide, BT/Epoxy, etc.

Inorganic material

Aluminum, Copperinvar-copper, ceramic, etc.





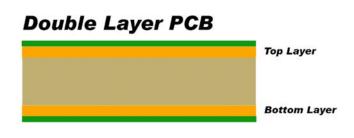
BY LAYER

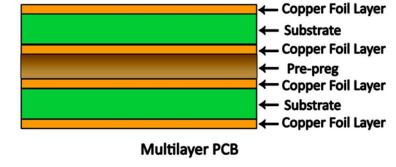
Single layer pcb

Two layer pcb

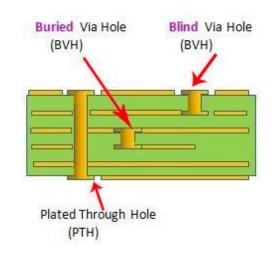
Multi layer pcb











a. Buried via hole board

b. Blind via hole board

c. Plated through hole board



1 Hot Air Levelling

Entek/OSP

Gold finger board

6 Immersion gold

Carbon oil board

Immersion Tin

Gold plating board

Immersion Silver

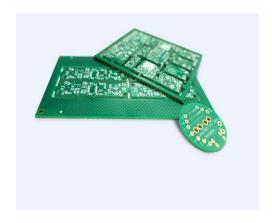


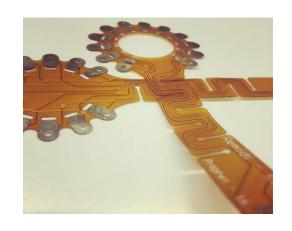
BY HARDNEDD

Rigid pcb

Flexible pcb

Rigid-Flex pcb



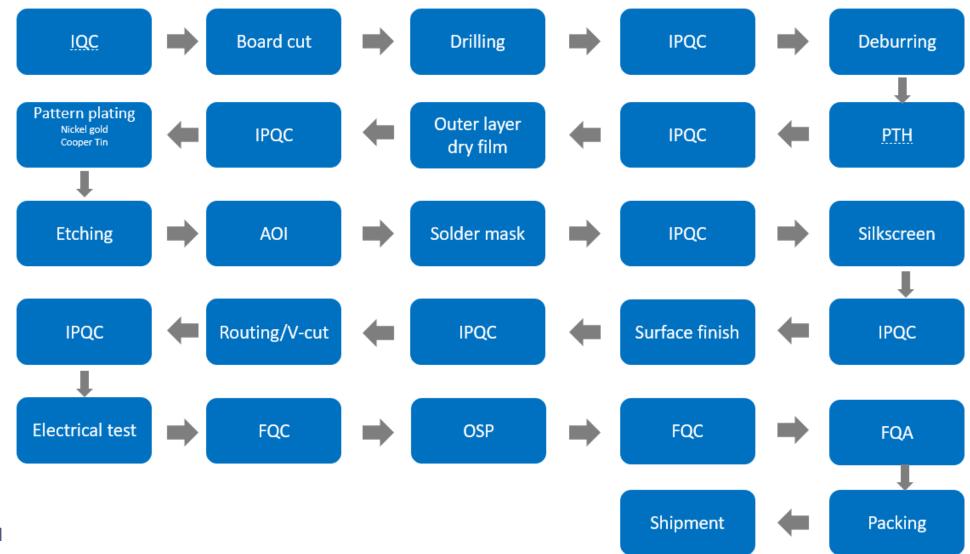






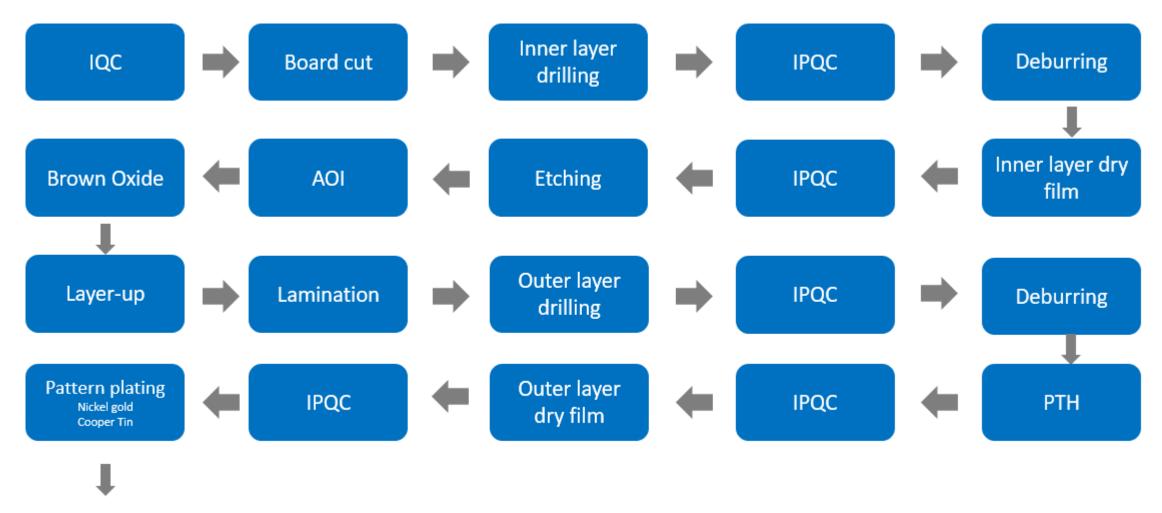
PCB MANUFACTURING PROCESS

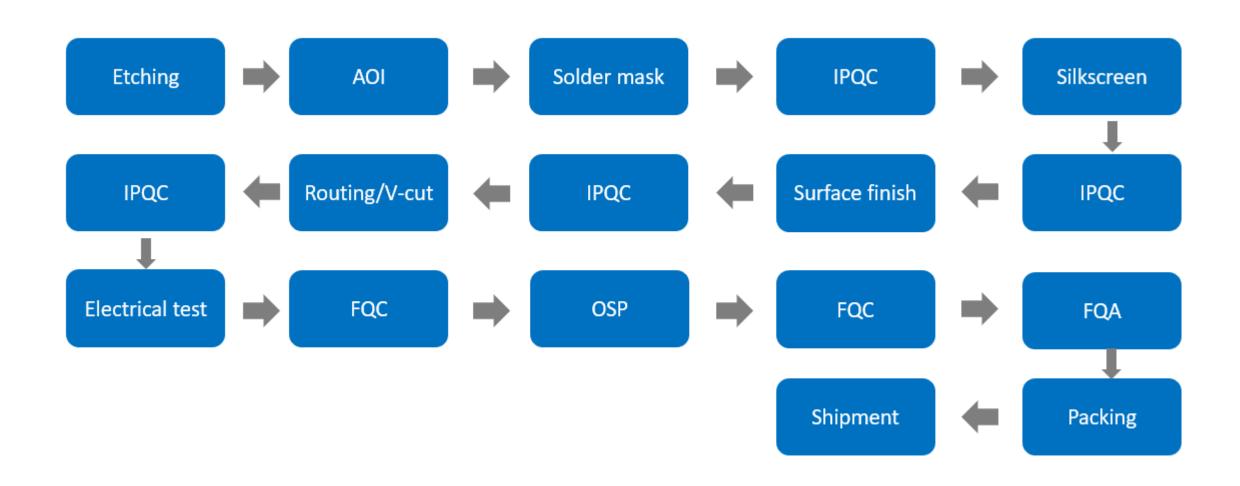
Double sided PCB manufacturing process



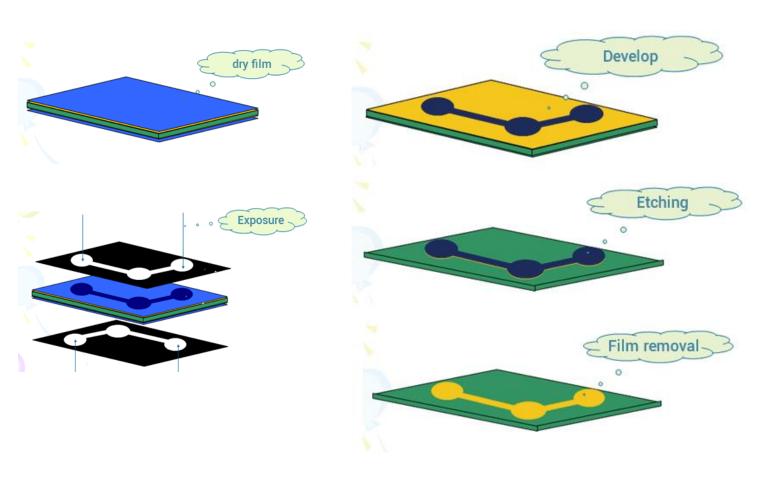


Multilayer PCB manufacturing process



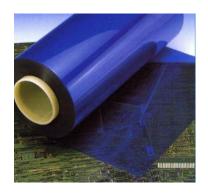






Dry film/ image transfer

Dry film is a kind of polymer compound, which can produce polymerization after irradiation of ultraviolet rays. Then will form a stable substance attached to the board surface, so as to achieve the function of blocking plating and etching.





Etching

Etching is using chemical way to remove unwanted copper from pcb. Then the circuit is appeared, usually acid is used to etch.

Brown Oxide

Making chemical oxidation of copper surfaces to generate oxides on the surface to increase roughness. It will improve adhesion.





AOI

Automated optical inspection (AOI) is an automated visual inspection of printed circuit board manufacture where a camera autonomously scans the device under test for both catastrophic failure (such as missing component) and quality defects.

It is commonly used in the manufacturing process because it is a non-contact test method. This guarantees the high reliability of Multi-CB multilayer circuit boards.





Electronic test/probe test

Combine Automatic optical alignment system and the traditional flying needle machine together, with the help of image-processing software and flying-pin-only cameras, flying probe test is easier and more accurate.

The layout is analysed according to the pcb file for short circuits and interruptions. This is important because only the E-test detects incorrect and broken conductors. And the detected defective circuit board will be marked.

Check https://www.youtube.com/watch?v=3wtkQx66mxk



Note: This flow is based on the most common pcb manufacturing process. Sometimes the manufacturing process will be adjusted accordingly to your pcb design requirement.





PCB prototype easy way